

SANYO Semiconductors DATA SHEET

An ON Semiconductor Company

MCH6602 — General-Purpose Switching Device Applications

Features

- · Low ON-resistance.
- · Ultrahigh-speed switching.
- 1.5V drive.
- · Composite type with 2 MOSFETs contained in a single package, facilitating high-density mounting.

Specifications

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	VDSS		30	٧
Gate-to-Source Voltage	VGSS		±10	V
Drain Current (DC)	ΙD		0.35	Α
Drain Current (Pulse)	IDP	PW≤10μs, duty cycle≤1%	1.4	Α
Allowable Power Dissipation	PD	Mounted on a ceramic board (900mm ² X0.8mm) 1unit	0.8	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C

Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			1.1
			min	typ	max	Unit
Drain-to-Source Breakdown Voltage	V(BR)DSS	ID=1mA, VGS=0V	30			V
Zero-Gate Voltage Drain Current	IDSS	V _{DS} =30V, V _{GS} =0V			1	μΑ
Gate-to-Source Leakage Current	IGSS	V _{GS} =±8V, V _{DS} =0V			±10	μΑ
Cutoff Voltage	VGS(off)	V _{DS} =10V, I _D =100μA	0.4		1.3	V
Forward Transfer Admittance	yfs	V _{DS} =10V, I _D =80mA	0.15	0.22		S
Static Drain-to-Source On-State Resistance	R _{DS} (on)1	ID=80mA, VGS=4V		2.9	3.7	Ω
	RDS(on)2	ID=40mA, VGS=2.5V		3.7	5.2	Ω
	R _{DS} (on)3	ID=10mA, VGS=1.5V		6.4	12.8	Ω
Input Capacitance	Ciss	V _{DS} =10V, f=1MHz		7.0		pF
Output Capacitance	Coss	V _{DS} =10V, f=1MHz		5.9		pF
Reverse Transfer Capacitance	Crss	V _{DS} =10V, f=1MHz		2.3		pF

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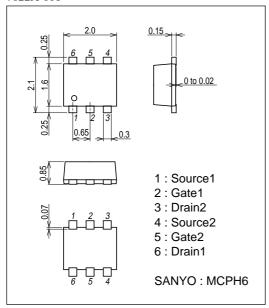
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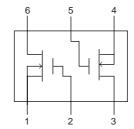
Parameter	Symbol	Conditions	Ratings			Unit
	Symbol		min	typ	max	Oill
Turn-ON Delay Time	t _d (on)	See specified Test Circuit.		19		ns
Rise Time	t _r	See specified Test Circuit.		65		ns
Turn-OFF Delay Time	t _d (off)	See specified Test Circuit.		155		ns
Fall Time	tf	See specified Test Circuit.		120		ns
Total Gate Charge	Qg	V _{DS} =10V, V _{GS} =10V, I _D =150mA		1.58		nC
Gate-to-Source Charge	Qgs	VDS=10V, VGS=10V, ID=150mA		0.26		nC
Gate-to-Drain "Miller" Charge	Qgd	V _{DS} =10V, V _{GS} =10V, I _D =150mA		0.31		nC
Diode Forward Voltage	V _{SD}	I _S =150mA, V _{GS} =0V		0.87	1.2	V

Package Dimensions

unit : mm 7022A-006



Electrical Connection



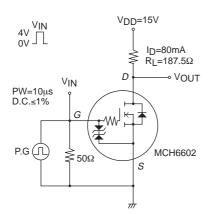
1 : Source1 2 : Gate1

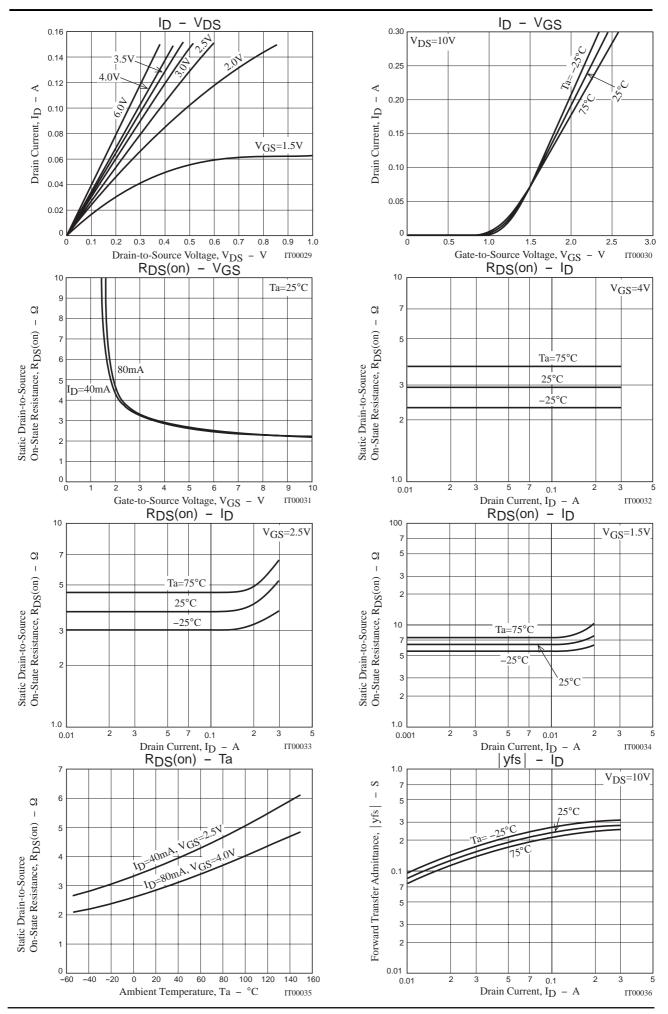
3 : Drain2

4 : Source2 5 : Gate2 6 : Drain1

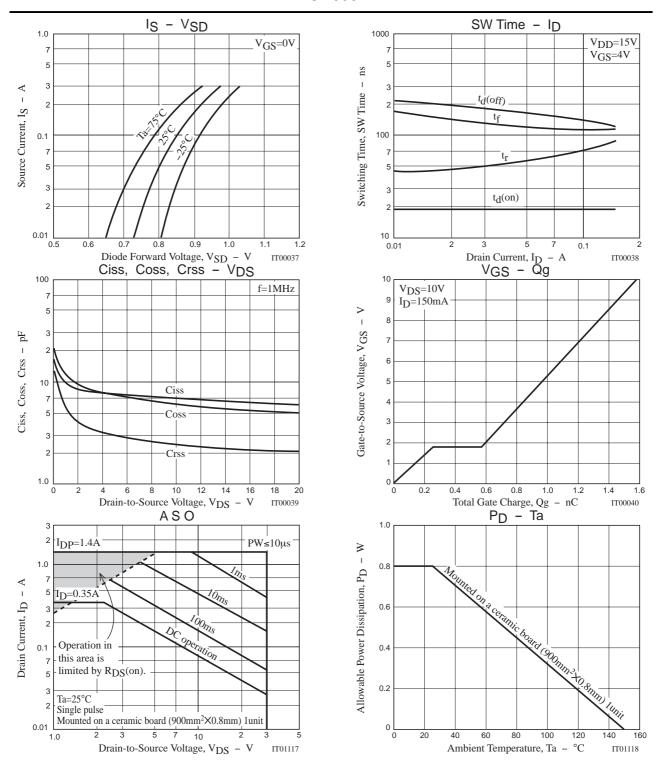
Top view

Switching Time Test Circuit





MCH6602



Note on usage: Since the MCH6602 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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